

PRODUCT / PROCESS CHANGE NOTIFICATION

1. PCN basic data

1.1 Company		STMicroelectronics International N.V
1.2 PCN No.	ANALOG MEMS SENSORS/25/15686	
1.3 Title of PCN	ST Manufacturing Reshaping (Analog_FE+EWS BCD9 AG200toAG300_all): Qualification of AG300 (Italy) as new FE location and CRO plant (France) as new EWS Location for BCD9 products	
1.4 Product Category	Please refer to the impacted Product list	
1.5 Issue date	2025-07-29	

2. PCN Team

2.1 Contact supplier	
2.1.1 Name	ROBERTSON HEATHER
2.1.2 Phone	+1 8475853058
2.1.3 Email	heather.robertson@st.com
2.2 Change responsibility	
2.2.1 Product Manager	Domenico ARRIGO,Marcello SAN BIAGIO,Nicola LIPORACE
2.1.2 Marketing Manager	Fabio CHELLI,Elena Maria PERNIGOTTI,Vito GRAZIANO,Matteo AMADEO,Salvatore DI VINCENZO
2.1.3 Quality Manager	Alessandro PLATINI,Alberto BIGNAZZI,Daniela FAZIO,Marcello Donato MENCHISE

3. Change

3.1 Category	3.2 Type of change	3.3 Manufacturing Location
Manufacturing reshaping program	Manufacturing reshaping program	New Front end plant : AG300 (Italy) New FE EWS plant : CRO (France)

4. Description of change

	Old	New
4.1 Description	Front end plant : AG200 (Italy) FE EWS plant : APEE / AF6E	Front end plant : AG300 (Italy) FE EWS plant : CRO (France)
4.2 Anticipated Impact on form,fit, function, quality, reliability or processability?	No Impact. The products guarantee the same quality and electrical characteristics as per current production.	

5. Reason / motivation for change

5.1 Motivation	In the frame of ST manufacturing reshaping program (refer to Corporate PCI 15383 - Early Notification), following the continuous improvement of our service and to increase production Capacity, ST Microelectronics is announcing the qualification of AG300 (Italy) as FE Location and CRO (France) as FE EWS plant for the impacted Products in BCD9 Technology. Please be advised that the enclosed list of products and dates could be subject to change. Such modifications may occur as part of the ongoing transformation program and will be communicated as and when available.
5.2 Customer Benefit	SERVICE CONTINUITY

6. Marking of parts / traceability of change

6.1 Description	Traceability of change will be ensured by an internal codification (Finished Good/Type) printed on the carton box label.
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7. Timing / schedule

7.1 Date of qualification results	2026-12-15
7.2 Intended start of delivery	2027-06-15
7.3 Qualification sample available?	Upon Request

8. Qualification / Validation

8.1 Description			
8.2 Qualification report and qualification results	In progress	Issue Date	

9. Attachments (additional documentations)
15686 Public product.pdf 15686 Qualification Plan Detail_EWS-adv BCD9.pdf

10. Affected parts		
10. 1 Current		10.2 New (if applicable)
10.1.1 Customer Part No	10.1.2 Supplier Part No	10.1.2 Supplier Part No
	L9026-B03N-TR	
	L9026-YO-TR	
	L9963-TR	
	L9963E-TR	
	L99BM114-TR	
	L99DZ300GTR	
	L99LDLH32TR	
	SPSB100BTR	
	STSPIN32G4	
	STSPIN32G4TR	

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Public Products List

Public Products are off the shelf products. They are not dedicated to specific customers, they are available through ST Sales team, or Distributors, and visible on ST.com

PCN Title : ST Manufacturing Reshaping (Analog_FE+EWS BCD9 AG200toAG300_all): Qualification of AG300 (Italy) as new FE location and CRO plant (France) as new EWS Location for BCD9 products

PCN Reference : ANALOG MEMS SENSORS/25/15686

Subject : Public Products List

Dear Customer,

Please find below the Standard Public Products List impacted by the change.

L9965A-TR	STSPIN32G4TR	L9963E
L99DZ300GTR	L9026-YO-TR	L9963E-TR
L99DZ320TR	L99LDLH32TR	SPSB100PTR
SPSB100BTR	L9026-B03N-TR	STSPIN32G4
L99BM114-TR		

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